

Technical Datasheet



Total Clean™ CFC Free Stencil Cleaner



Product Name

Total Clean 130 CFC Free Stencil Cleaner

Manufactured By

Warton Metals Limited
Grove Mill, Commerce Street
Haslingden Lancashire
BB4 5JT
ENGLAND

Tel: +44 (0)1706 218888
Fax: +44 (0)1706 221188

Description

Total Clean 130 is a CFC free cleaning solution developed to replace Trych's and to cut down on the use of CFC's. Total Clean 130 is a stencil cleaner with a moderate evaporation rate for

removal of rosin, modified rosin and no clean solder paste.

Applications

Total Clean 130 is virtually odourless, easy to use and ozone friendly.

Packaging

Total Clean 130 is supplied in 500ml trigger bottles and 10 and 25 Litre containers.

Have You Tried Our Solder Paste?

Warton manufacture a range of no clean and water wash solder pastes available for all printing applications.

Future No Clean Solder Paste

The Future range of no clean solder pastes are designed for applications requiring extreme low slump, no solder balling, excellent printability with long tack/stencil life. Future offers rapid, efficient soldering of even the most difficult of assemblies, leaving only minimal clear residue after reflow. Future is formulated for nitrogen and air reflow processes. Future is available with both activated and halide free flux formulations, three powder sizes, four viscosity ranges and in all Warton High Purity Solder Alloys. A dispensing grade version of Future No Clean Solder Paste is also available.

Hydro Flux Water Wash Solder Paste

A water wash, colophony free solder paste suitable for applications where washing is necessary. Hydro flux is available in both nitrogen and air reflow formulations.

Further Information

Please do not hesitate to contact Sales & Technical Enquiries on Tel: 01706 218888 or Fax: 01706 221188 for more information.